$0.16^{+0.1}$ 

Unit: mm

# **MA3X721** (MA721)

### Silicon epitaxial planar type

For super high speed switching For small current rectification

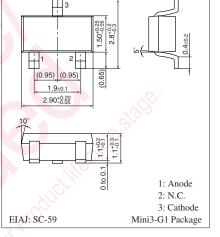
#### Features

• Forward current (Average)  $I_{F(AV)} = 200$  mA rectification is possible

Absolute Maximum R	atings T <sub>a</sub> :	= 25°C	
Parameter	Symbol	Rating	Unit
Reverse voltage	V <sub>R</sub>	30	V
Maximum peak reverse voltage	V <sub>RM</sub>	30	V
Forward current	I <sub>F</sub>	200	mA
Peak forward current	I <sub>FM</sub>	300	mA
Non-repetitive peak forward surge current *	I <sub>FSM</sub>	1	А
Junction temperature	Tj	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

Note) \*: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)

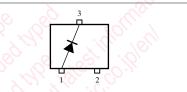
#### 



0.40+0.10

#### Marking Symbol: M1M

#### Internal Connection



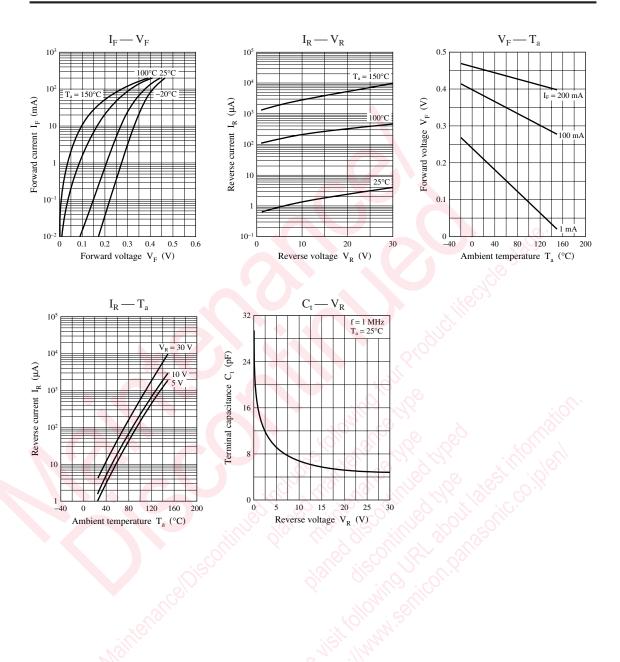
#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 200 mA	$\sim 2^{\circ}$		0.55	V
Reverse current	I <sub>R</sub>	$V_R = 30 V$			50	μΑ
Terminal capacitance	Ct	$V_R = 0 V, f = 1 MHz$		30		pF
Reverse recovery time *	t <sub>rr</sub>	$I_F = I_R = 100 \text{ mA}$		3.0		ns
a contraction of the second		$I_{rr} = 10 \text{ mA}, R_L = 100 \Omega$				

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

- 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
- 3. Absolute frequency of input and output is 1 GHz.
- 4. \*: trr measurement circuit Bias Application Unit (N-50BU) Input Pulse Output Pulse 109 00% = 10 mA $t_p = 2 \ \mu s$ 100<sup>''</sup>mA = 0.35 ns= 100 mA Pulse Generator Wave Form Analyzer I<sub>R</sub> : R<sub>I</sub>  $\delta = 0.05$  $= 100 \Omega$ (PG-10N) (SAS-8130)  $R_s = 50 \Omega$  $R_i = 50 \Omega$ Note) The part number in the parenthesis shows conventional part number.

## **Panasonic**



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